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Vishay Siliconix

# N-Channel 200 V (D-S) 175 °C MOSFET



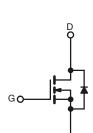
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	200				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0216				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0235				
Q <sub>g</sub> typ. (nC)	31.6				
I <sub>D</sub> (A)	64				
Configuration	Single				

#### **FEATURES**

- ThunderFET® power MOSFET
- Low R<sub>DS</sub> Q<sub>g</sub> figure-of-merit (FOM)
- Maximum 175 °C junction temperature
- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **APPLICATIONS**

- · Synchronous rectification
- Power supplies
- DC/AC inverter
- DC/DC converter
- · Solar micro inverter
- Motor drive switch



COMPLIANT

HALOGEN

**FREE** 

N-Channel MOSFET

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free and halogen-free	SUP90220E-GE3		

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	200	.,
Gate-source voltage		V <sub>GS</sub>	± 20	V
Oction and discount	T <sub>C</sub> = 25 °C		64	
Continuous drain current	T <sub>C</sub> = 125 °C	I <sub>D</sub>	37	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	100	А
Continuous source-drain diode current		I <sub>S</sub>	64.7	
Single pulse avalanche current <sup>a</sup> Single pulse avalanche energy <sup>a</sup> L = 0.1 mH		I <sub>AS</sub>	45	
		E <sub>AS</sub>	101	mJ
Maritim and a different control	T <sub>C</sub> = 25 °C		230 <sup>b</sup>	14/
Maximum power dissipation	T <sub>C</sub> = 125 °C	P <sub>D</sub>	77 <sup>b</sup>	- W
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	90
Soldering recommendations (peak temperature) <sup>c</sup>		1	260	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	MAXIMUM	UNIT		
Maximum junction-to-ambient (PCB mount) c		R <sub>thJA</sub>	40	°C/W		
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.65	C/W		

#### Notes

- a. Duty cycle  $\leq$  1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).



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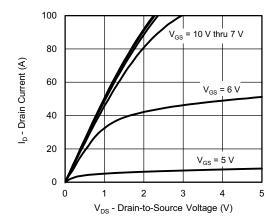
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	250	nA
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	-	150	
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175  ^{\circ}\text{C}$	-	-	5	mA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α
Drain-source on-state resistance a	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A - 0.0180		0.0180	0.0216	
Dialii-Source oii-state resistance "	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0188	0.0235	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 15 \text{ A}$	-	37	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	1950	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	170	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	15	-	
Total gate charge	Qg		-	31.6	48	nC
Gate-source charge	$Q_{gs}$	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$	-	8.6	-	
Gate-drain charge	$Q_{gd}$		-	7.6	-	
Gate resistance	Rg	f = 1 MHz	0.6	3	6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	
Rise time	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, R_L = 8.3 \Omega, I_D \cong 12 \text{ A},$	-	35	53	no
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	28	42	- ns -
Fall time	t <sub>f</sub>		-	38	57	
<b>Drain-Source Body Diode Characteristi</b>	cs					
Pulse diode forward current (t = 100 μs)	I <sub>SM</sub>		-	-	100	Α
Body diode voltage	$V_{SD}$	I <sub>F</sub> = 12 A, V <sub>GS</sub> = 0 V	-	0.85	1.5	V
Body diode reverse recovery time	t <sub>rr</sub>		-	120	180	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	L_ = 12 A di/d+ = 100 A/vo	-	0.91	1.37	μC
Reverse recovery fall time	t <sub>a</sub>	I <sub>F</sub> = 12 A, di/dt = 100 A/μs	-	95	-	
Reverse recovery rise time	t <sub>b</sub>		-	25	-	ns
Body diode peak reverse recovery charge	I <sub>RM(REC)</sub>		-	12	18	Α

### Notes

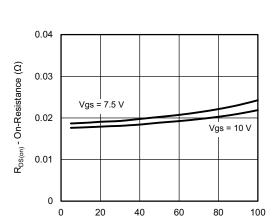
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



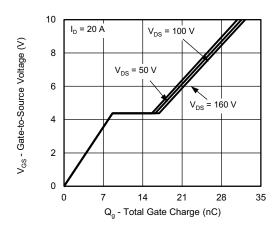


#### **Output Characteristics**

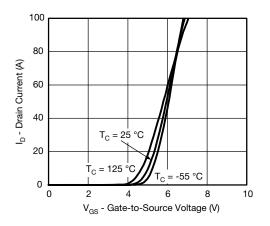


On-Resistance vs. Drain Current and Gate Voltage

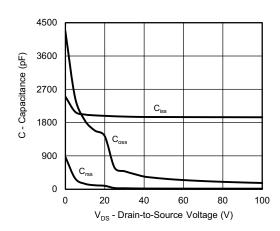
I<sub>D</sub> - Drain Current (A)



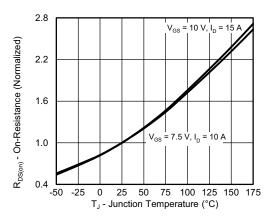
**Gate Charge** 



**Transfer Characteristics** 

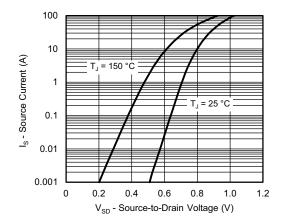


Capacitance

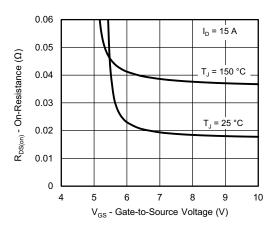


On-Resistance vs. Junction Temperature

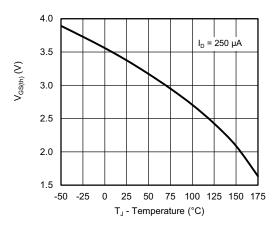




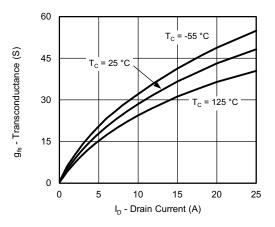
Source-Drain Diode Forward Voltage



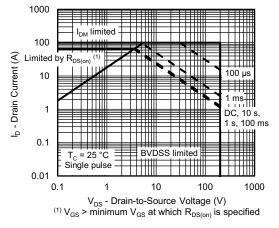
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

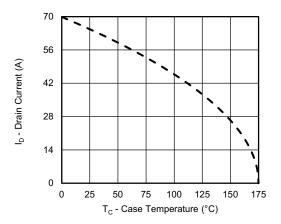


Transconductance

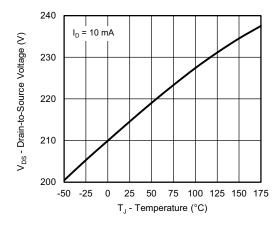


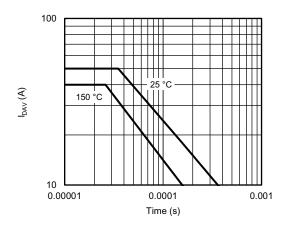
Safe Operating Area, Junction-to-Ambient





### Current Derating a





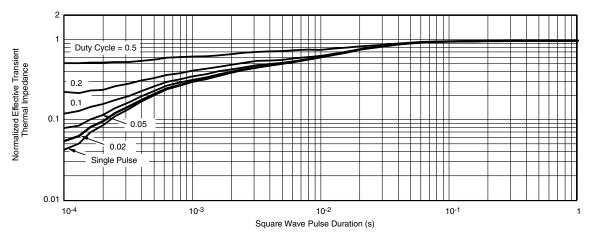
Drain Source Breakdown vs. Junction Temperature

 $I_{\text{DAV}}$  vs. Time

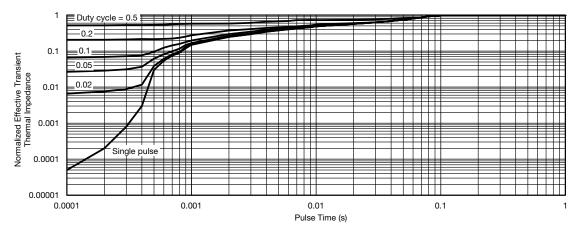
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



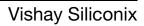


Normalized Thermal Transient Impedance, Junction-to-Ambient



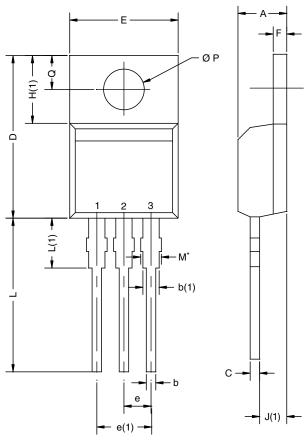
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?75261">www.vishay.com/ppg?75261</a>.





## **TO-220AB**



- 6	e(1) <del>-</del>	
		D2

	MILLIM	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471					

#### Note

 $<sup>^{\</sup>star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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